Preferred Devices

Complementary Power Transistors

D²PAK for Surface Mount

... for general purpose power amplification and switching such as output or driver stages in applications such as switching regulators, converters and power amplifiers.

- Low Collector–Emitter Saturation Voltage –
 V_{CE(sat)} = 1.0 V (Max) @ 8.0 A
- Fast Switching Speeds
- Complementary Pairs Simplifies Designs
- Epoxy Meets UL 94, V-O @ 0.125 in
- ESD Ratings: Human Body Model, 3B > 8000 V Machine Model, C > 400 V

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector–Emitter Voltage	V _{CEO}	80	Vdc
Emitter-Base Voltage	V _{EB}	5	Vdc
Collector Current – Continuous – Peak	I _C	10 20	Adc
Total Power Dissipation @ T _C = 25°C Derate above 25°C	P _D	50 1.67	Watts W/°C
Total Power Dissipation @ T _A = 25°C Derate above 25°C	P _D	2.0 0.016	Watts W/°C
Operating and Storage Junction Temperature Range	T _J , T _{stg}	-55 to 150	°C

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	$R_{\theta JC}$	2.5	°C/W
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	75	°C/W



http://onsemi.com

SILICON POWER
TRANSISTORS
10 AMPERES
80 VOLTS
50 WATTS

MARKING DIAGRAM



D²PAK CASE 418B STYLE 1



Y = Year WW = Work Week

B4xH11 = Specific Device Code

= 4 or 5

ORDERING INFORMATION

Device	Package	Shipping [†]
MJB44H11	D ² PAK	50 Units/Rail
MJB44H11T4	D ² PAK	800/Tape & Reel
MJB45H11	D ² PAK	50 Units/Rail
MJB45H11T4	D ² PAK	800/Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

Preferred devices are recommended choices for future use and best overall value.

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Characteristic		Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS		•	•	•		
Collector–Emitter Sustaining Voltage $(I_C = 30 \text{ mA}, I_B = 0)$		V _{CEO(sus)}	80	_	-	Vdc
Collector Cutoff Current $(V_{CE} = Rated V_{CEO}, V_{BE} = 0)$		I _{CES}	_	_	10	μА
Emitter Cutoff Current (V _{EB} = 5 Vdc)		I _{EBO}	_	_	50	μА
ON CHARACTERISTICS						
Collector–Emitter Saturation Voltage (I _C = 8 Adc, I _B = 0.4 Adc)		V _{CE(sat)}	-	_	1.0	Vdc
Base–Emitter Saturation Voltage $(I_C = 8 \text{ Adc}, I_B = 0.8 \text{ Adc})$		V _{BE(sat)}	_	-	1.5	Vdc
DC Current Gain (V _{CE} = 1 Vdc, I _C = 2 Adc)		h _{FE}	60	_	-	-
DC Current Gain (V _{CE} = 1 Vdc, I _C = 4 Adc)			40	_	-	
DYNAMIC CHARACTERISTICS						•
Collector Capacitance (V _{CB} = 10 Vdc, f _{test} = 1 MHz)	MJB44H11 MJB45H11	C _{cb}	<u>-</u>	130 230	- -	pF
Gain Bandwidth Product $(I_C = 0.5 \text{ Adc}, V_{CE} = 10 \text{ Vdc}, f = 20 \text{ MHz})$	MJB44H11 MJB45H11	f _T	_ _	50 40		MHz
SWITCHING TIMES						
Delay and Rise Times (I _C = 5 Adc, I _{B1} = 0.5 Adc)	MJB44H11 MJB45H11	t _d + t _r	- -	300 135	- -	ns
Storage Time $(I_C = 5 \text{ Adc}, I_{B1} = I_{B2} = 0.5 \text{ Adc})$	MJB44H11 MJB45H11	t _s	_ _	500 500		ns
Fall Time $(I_C = 5 \text{ Adc}, I_{B1} = I_{B2} = 0.5 \text{ Adc})$	MJB44H11 MJB45H11	t _f	_ _	140 100		ns

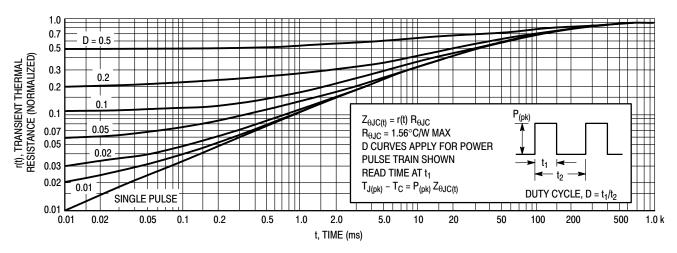


Figure 1. Thermal Response

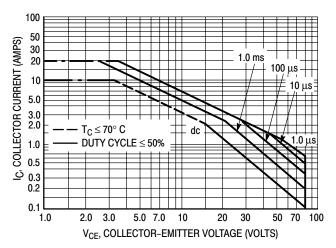


Figure 2. Maximum Rated Forward Bias Safe Operating Area

There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate $I_C - V_{CE}$ limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

The data of Figure 2 is based on $T_{J(pk)} = 150^{\circ}C$; T_C is variable depending on conditions. Second breakdown pulse limits are valid for duty cycles to 10% provided $T_{J(pk)} \le 150^{\circ}C$. $T_{J(pk)}$ may be calculated from the data in Figure 1. At high case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by second breakdown.

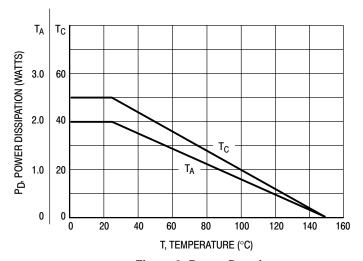


Figure 3. Power Derating

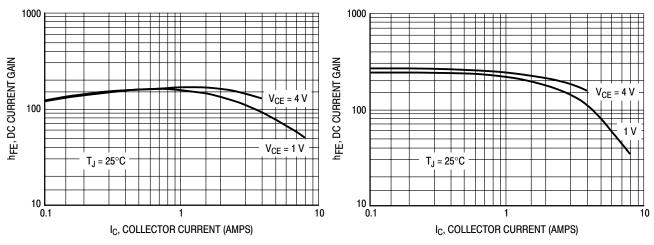


Figure 4. MJB44H11 DC Current Gain

Figure 5. MJB45H11 DC Current Gain

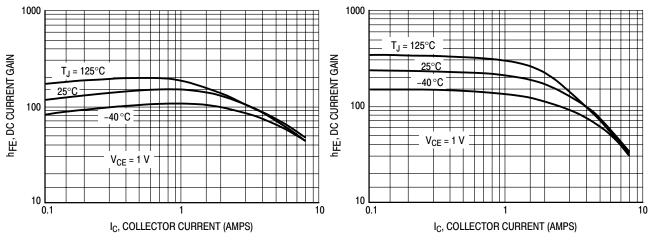


Figure 6. MJB44H11 Current Gain versus Temperature

Figure 7. MJB45H11 Current Gain versus Temperature

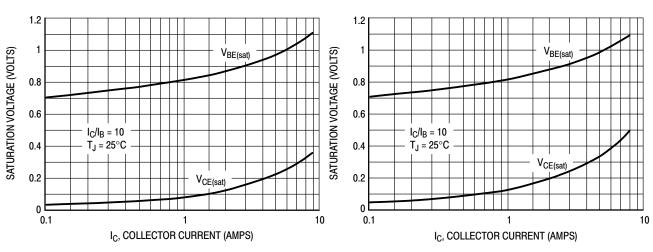
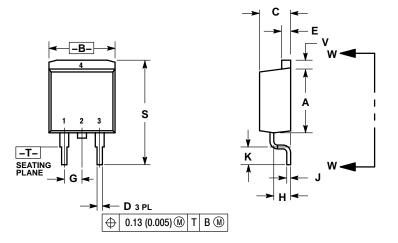


Figure 8. MJB44H11 On-Voltages

Figure 9. MJB45H11 On-Voltages

PACKAGE DIMENSIONS

D²PAK CASE 418B-04 **ISSUE H**



NOTES:

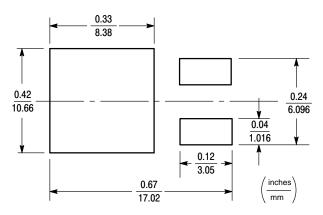
- NOTES:
 1. DIMENSIONING AND TOLERANCING
 PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.
 3. 418B-01 THRU 418B-03 OBSOLETE,
 NEW STANDARD 418B-04.

	INCHES		MILLIMETERS		
DIM	MIN	MAX	MIN	MAX	
Α	0.340	0.380	8.64	9.65	
В	0.380	0.405	9.65	10.29	
С	0.160	0.190	4.06	4.83	
D	0.020	0.035	0.51	0.89	
E	0.045	0.055	1.14	1.40	
F	0.310	0.350	7.87	8.89	
G	0.100	BSC	2.54 BSC		
Н	0.080	0.110	2.03	2.79	
J	0.018	0.025	0.46	0.64	
K	0.090	0.110	2.29	2.79	
L	0.052	0.072	1.32	1.83	
M	0.280	0.320	7.11	8.13	
N	0.197 REF		5.00 REF		
Р	0.079 REF		2.00 REF		
R	0.039	0.039 REF		REF	
S	0.575	0.625	14.60	15.88	
V	0.045	0.055	1 14	1 40	



- 2. COLLECTOR 3. EMITTER 4. COLLECTOR
- VARIABLE CONFIGURATION ZONE M М M VIEW W-W VIEW W-W VIEW W-W

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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